

L Number	Hits	Search Text	DB	Time stamp
1	92	ceramic adj capacitor and laminated near body and baking	USPAT; US-PGPUB; EP ; JPO; DERWENT; IBM_TDB	2004/03/02 11:56
2	2	6349026.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/02 11:49
3	0	6349026.URPN.	USPAT	2004/03/02 11:49
4	0	6349026.URPN.	USPAT	2004/03/02 11:55
5	6	capacitor and laminated near body and baking and common adj material	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/02 12:20
6	6	("4982485" "5426560" "5822176" "5841626" "5995360" "6002577").PN.	USPAT	2004/03/02 11:57
7	7	("4574329" "4610971" "4985381" "5036424" "5117326" "5659456" "5734545").PN.	USPAT	2004/03/02 12:04
8	6	("3237066" "3679950" "3720862" "3879645" "3902102" "4447853").PN.	USPAT	2004/03/02 12:17
9	18	ceramic adj capacitor and laminated near body and baking and 29/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/02 12:21
10	17	ceramic adj capacitor and laminated near body and baking and (29/25.42, 29/25.41 , 29/831 , 29/846).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/02 12:23
11	36	ceramic adj capacitor and laminated near body and baking and (29/25.42; 29/611 ; 29/612 ; 29/25.41 ; 29/830 ; 361/321.2 ; 361/321.4 ; 361/321.5 ; 361/303 ; 501/32 ; 501/136 ; 501/137).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/02 12:38
12	7	("5731950" "5742473" "5801111" "5815368" "5822176" "5835340" "5862034").PN.	USPAT	2004/03/02 12:29
13	4	ceramic adj capacitor and laminated near body and inner adj electrodes and external near electr des and baking and (29/25.42; 29/611 ; 29/612 ; 29/25.41 ; 29/830 ; 361/321.2 ; 361/321.4 ; 361/321.5 ; 361/303 ; 501/32 ; 501/136 ; 501/137).ccls.	USPAT; US-PGPUB; EPO; JP ; DERWENT; IBM_TDB	2004/03/02 12:43

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14	0	unbaked near ceramic adj capacit r and laminated near body and inner adj electrodes and external near electrodes and baking and (29/25.42; 29/611 ; 29/612 ; 29/25.41 ; 29/830 ; 361/321.2 ; 361/321.4 ; 361/321.5 ; 361/303 ; 501/32 ; 501/136 ; 501/137).ccls.	USPAT; US-PGPUB; EP ; JP ; DERWENT; IBM_TDB	2004/03/02 12:44
15	0	unbaked near ceramic and laminated near body and inner adj electrodes and external and baking	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/02 12:44
16	6	unbaked near ceramic and laminated near body and baking	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/02 12:47
17	6	3090987.URPN.	USPAT	2004/03/02 12:46
18	2	5600101.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/02 12:54
19	1	1996-148778.NRAN.	DERWENT	2004/03/02 12:48
20	2	5181044.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/02 12:54

	Titl	Current OR	Current XR f	Retrieval Clas if
1	M th od of producing electronic parts, and m ber for production thereof	29/846		29/846
2	M th d of forming an electronic c mponent using ink	347/44	29/830; 29/831; 29/846; 29/890.1; 347/20	29/831; 29/846
3	Multilayer ceramic electronic components and methods for manufacturing the same	29/25.42	29/25.41; 29/831; 29/846	29/25.41; 29/25.42; 29/831; 29/846
4	M th d of forming an electronic c mponent using ink	29/890.1	252/62.51R; 29/830; 29/831; 29/852; 427/190; 427/201; 427/205; 427/96; 427/97	29/831
5	M th d of producing a monolithic ceramic capacitor	29/25.42	29/25.41; 29/830; 501/136; 501/32	29/25.41; 29/25.42
6	M th d for manufacturing a multilayered ceramic electronic component	432/17	29/25.42; 432/121	29/25.42

	Titl	Curr nt OR	Current XRef	Retri val Classif
7	Multilayer ceramic capacitor	361/306.3	29/25.42; 361/303; 361/306.1; 361/310; 361/321.2	29/25.42
8	El ctroic component having external el ctrodes and method for the manufacture thereof	361/308.1	29/25.41; 361/309; 361/321.2	29/25.41
9	Laminated ceramic electronic part including a plurality of internal electrodes having two leading portions and a n n- xposed portion between the two l ading portions	361/303	257/E21.53; 29/25.42; 361/306.3; 361/313	29/25.42
10	Laminated capacitor and trimming method th r of	361/303	29/25.42; 361/306.1; 361/306.3; 361/309; 361/329	29/25.42
11	C ramic capacitor with a grain b undary-insulated structure	29/25.03	252/513; 252/514; 252/519.12; 29/25.42; 361/311; 361/321.5	29/25.42
12	C ramic capacitor and method for the pr paration thereof	361/321.5	29/25.42	29/25.42

	Titl	Curr nt OR	Current XRef	R tri val Classif
13	S miconductor-type laminated ceramic capacitor with a grain boundary-insulated structure and a method for producing the same	361/321.4	29/25.42; 501/135	29/25.42
14	Laminated semiconductor ceramic capacitor with a grain boundary-insulated structure and a method for producing the same	361/321.5	156/89.16; 252/519.12; 29/25.42	29/25.42
15	Multilayer capacitor and method of fabricating the same	361/321.2	29/25.42; 361/309	29/25.42
16	S miconductor-type laminated ceramic capacitor with a grain boundary-insulated structure and a method for producing the sam	361/321.4	29/25.42; 501/135	29/25.42
17	High-voltage ceramic capacitor and m thod of producing the same	361/321.2	29/25.42; 361/328	29/25.42